

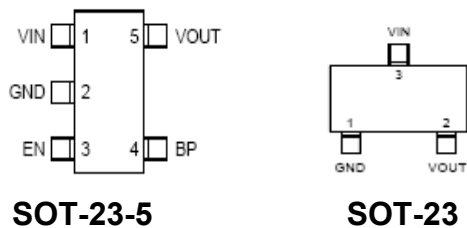
300mA, Ultra-Low Noise

Ultra-fast CMOS LDO Regulator

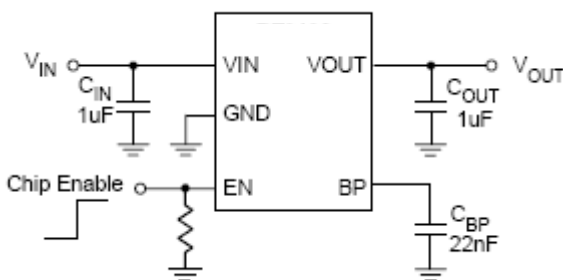
General Description

The LP3987 is designed for portable RF and wireless applications with demanding performance and space requirements. The LP3987 performance is optimized for battery-powered systems to deliver ultra low noise and low quiescent current. A noise bypass pin is available for further reduction of output noise. Regulator ground current increases only slightly in dropout, further prolonging the battery life. The LP3987 also works with low-ESR ceramic capacitors, reducing the amount of board space necessary for power applications, critical in hand-held wireless devices. The LP3987 consumes less than 0.01 μ A in shutdown mode and has fast turn-on time less than 50 μ s. The other features include ultra low dropout voltage, high output accuracy, current limiting protection, and high ripple rejection ratio. Available in the 5-lead of SOT-23 packages.

Pin Configurations



Typical Application Circuit



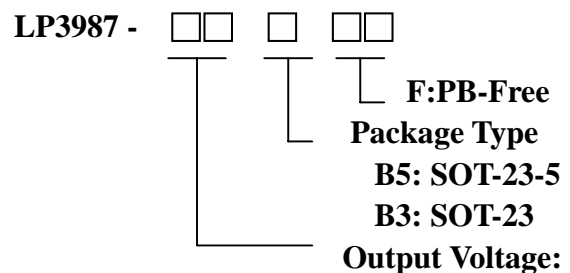
Features

- ◆ Ultra-Low-Noise for RF Application
- ◆ 2.5V- 6V Input Voltage Range
- ◆ Low Dropout : 220mV @ 300mA
- ◆ High PSSR:-80dB at 1KHz
- ◆ < 0.01 μ A Standby Current When Shutdown
- ◆ TTL-Logic-Controlled Shutdown Input
- ◆ Custom Voltage Available
- ◆ Ultra-Fast Response in Line/Load Transient
- ◆ Quick Start-Up (Typically 50 μ s)
- ◆ Current Limiting and Thermal Shutdown Protection

Applications

- ◇ PMP/PDA/MP3 players
- ◇ Cellular and Mobile phone
- ◇ RF Module
- ◇ Sensor Module

Ordering Information



SOT23-5(B5) Type:								
Type	A	B	C	D	E	H	F	G
Voltage(V)	1.5	1.8	2.5	2.7	2.8	2.85	3.0	3.3
SOT23 (B3) Type:								
Type	A	B	C	D	E	H	F	G
Voltage(V)	1.5	1.8	2.0	2.1	2.5	2.8	3.0	3.3

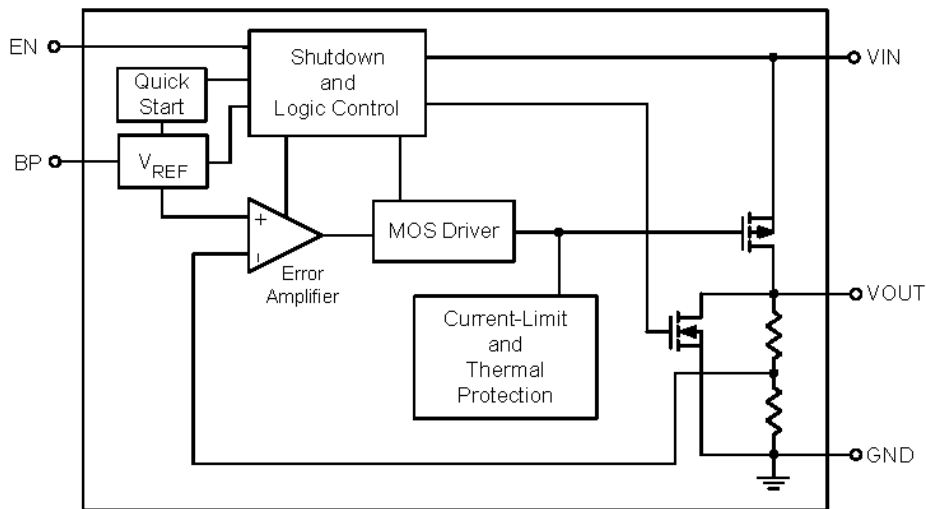
Note:

1. Output Voltage range from 1.5V to 3.3V;
2. 2.85V output order is LP3987-HB5F.

Functional Pin Description

Pin Name	Pin Function
EN	Chip Enable (Active High). Note that this pin is high impedance. There should be a pull low 100kΩ resistor connected to GND when the control signal is floating.
BP	Reference Noise Bypass
GND	Ground
VOUT	Output Voltage
VIN	Power Input Voltage

Function Block Diagram



Absolute Maximum Ratings

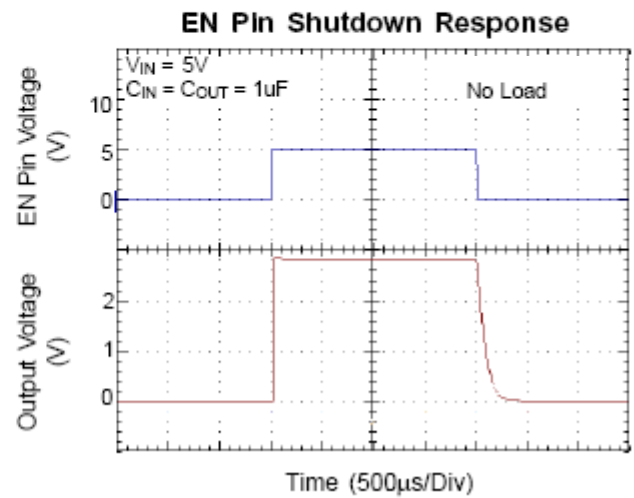
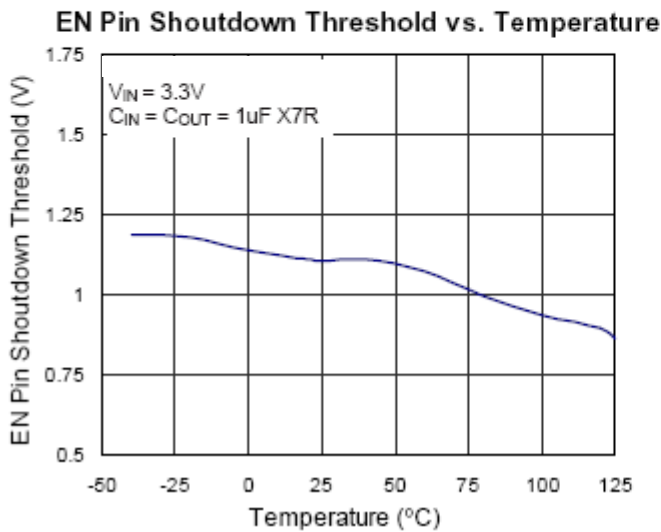
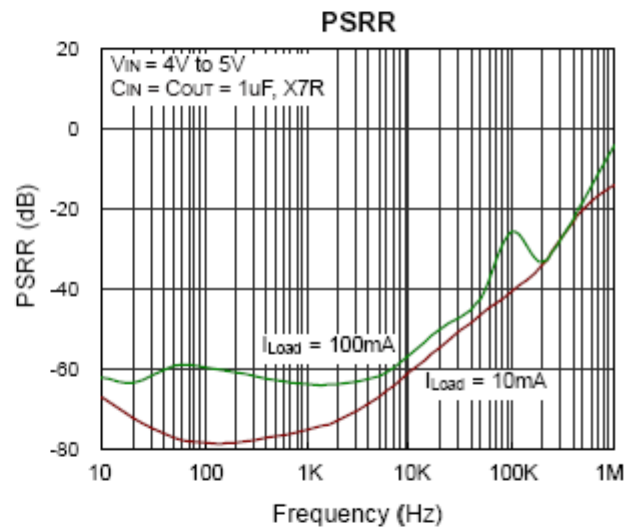
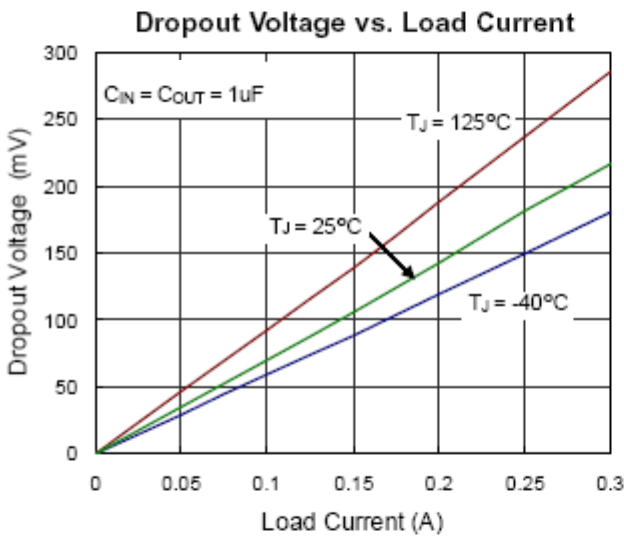
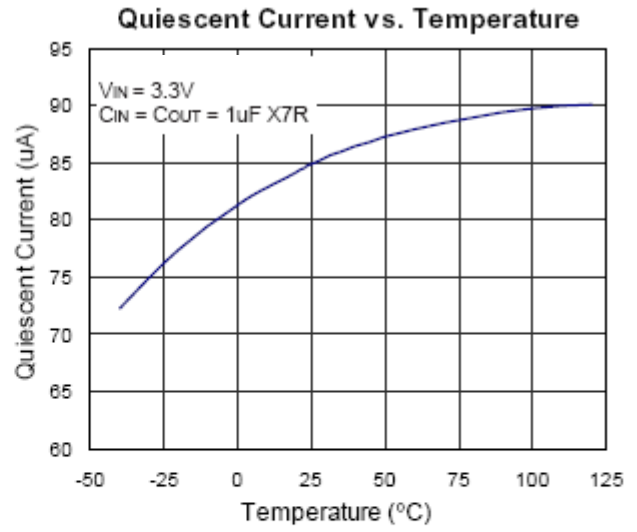
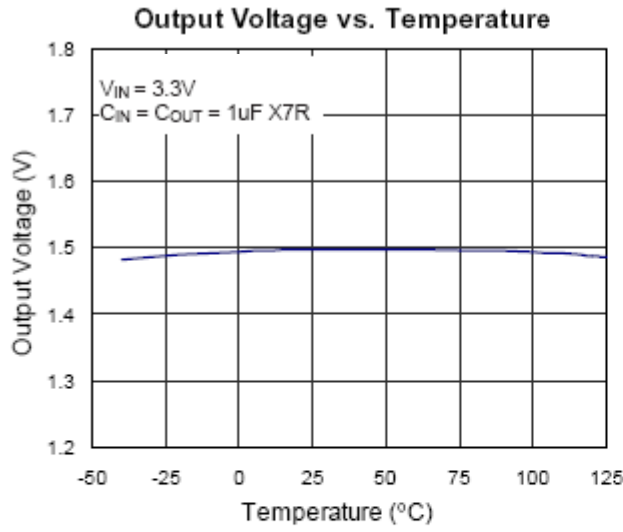
Supply Input Voltage	-----6V
Power Dissipation, PD @ TA = 25°C	
SOT-23-5	-----400mW
Package Thermal Resistance	
SOT-23-5, θJA	-----250°C/W
Lead Temperature (Soldering, 10 sec.)	-----260°C
Storage Temperature Range	-----65°C to 150°C
ESD Susceptibility	
HBM (Human Body Mode)	-----2kV
MM(Machine-Mode)	-----200V
Recommended Operating Conditions	
Supply Input Voltage	-----2.5V to 5.5V
EN Input Voltage	-----0V to 5.5V
Operation Junction Temperature Range	-----40°C to 125°C
Operation Ambient Temperature Range	-----40°C to 85°C

Electrical Characteristics

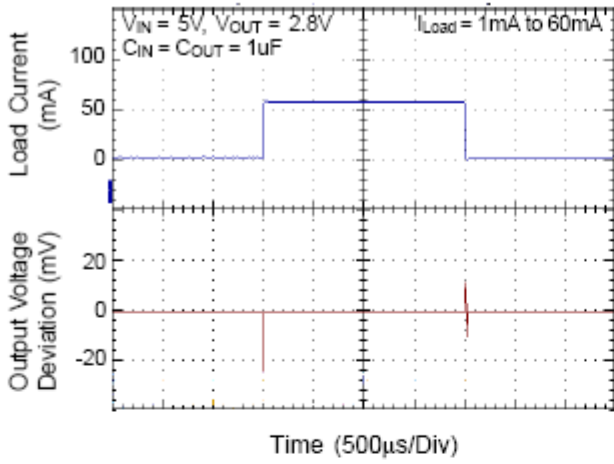
(VIN = VOUT + 1V, CIN = COUT = 1 μ F, CBP = 22nF, TA = 25° C, unless otherwise specified)

Parameter		Symbol	Test Conditions	Min	Typ	Max	Units
Output Voltage Accuracy		ΔV_{OUT}	I _{OUT} = 1mA	-2	--	+2	%
Current Limit		I _{LIM}	R _{LOAD} = 1 Ω	360	400		mA
Quiescent Current		I _Q	V _{EN} \geq 1.2V, I _{OUT} = 0mA		90	130	μ A
Dropout Voltage		V _{DROP}	I _{OUT} = 200mA, V _{OUT} > 2.8V		170	200	mV
			I _{OUT} = 300mA, V _{OUT} > 2.8V		220	300	
Line Regulation		ΔV_{LINE}	V _{IN} = (V _{OUT} + 1V) to 5.5V, I _{OUT} = 1mA			0.3	%
Load Regulation		ΔV_{LOAD}	1mA < I _{OUT} < 300mA			0.6	%
Standby Current		I _{STBY}	V _{EN} = GND, Shutdown		0.01	1	μ A
EN Input Bias Current		I _{IBSD}	V _{EN} = GND or V _{IN}		0	100	nA
EN Threshold	Logic-Low Voltage	V _{IL}	V _{IN} = 3V to 5.5V, Shutdown			0.4	V
	Logic-High Voltage	V _{IH}	V _{IN} = 3V to 5.5V, Start-Up	1.2			
Output Noise Voltage		e _{NO}	10Hz to 100kHz, I _{OUT} = 200mA C _{OUT} = 1 μ F		100		μ V _{RMS}
Power Supply	f = 100Hz	PSRR	C _{OUT} = 1 μ F, I _{OUT} = 10mA		-80		DB
Rejection Rate	f = 10kHz				-55		
Thermal Shutdown Temperature		TSD			165		° C

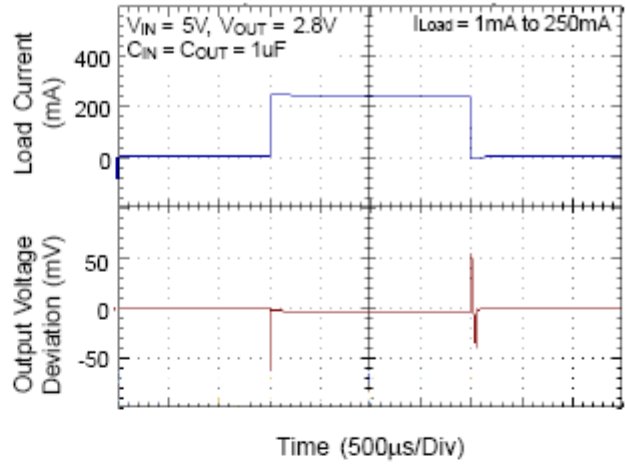
Typical Operating Characteristics



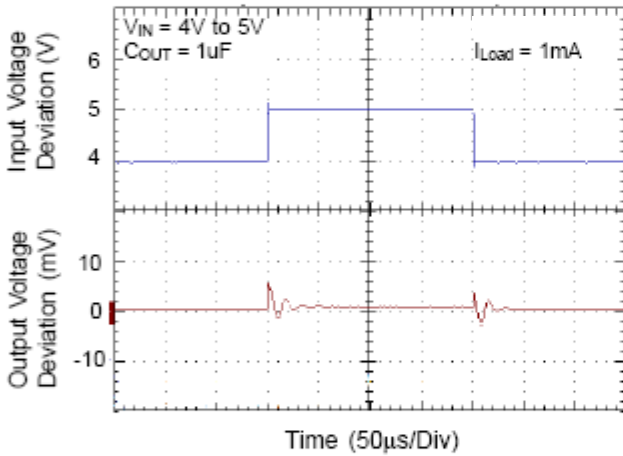
Load Transient Response



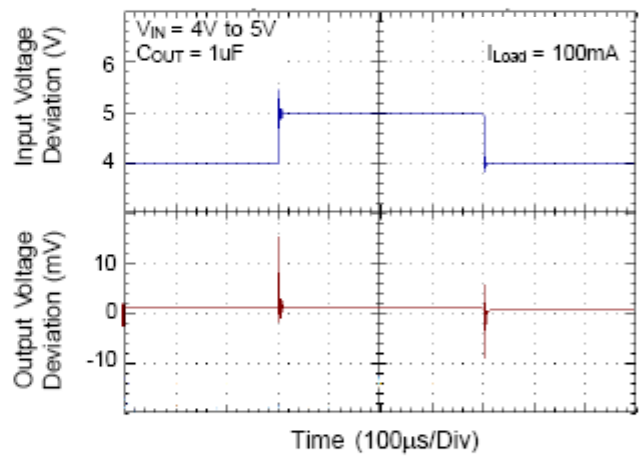
Load Transient Response



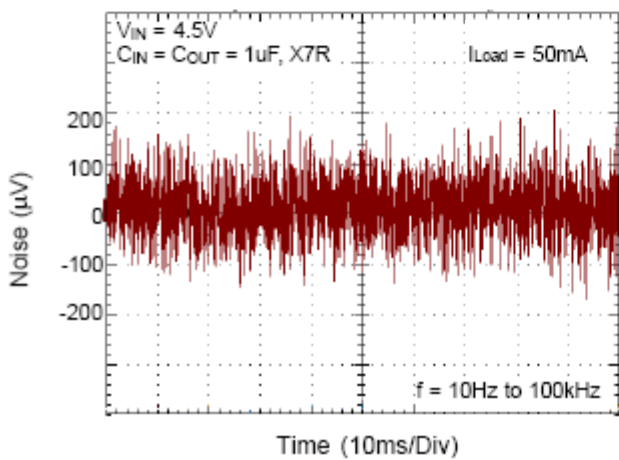
Line Transient Response



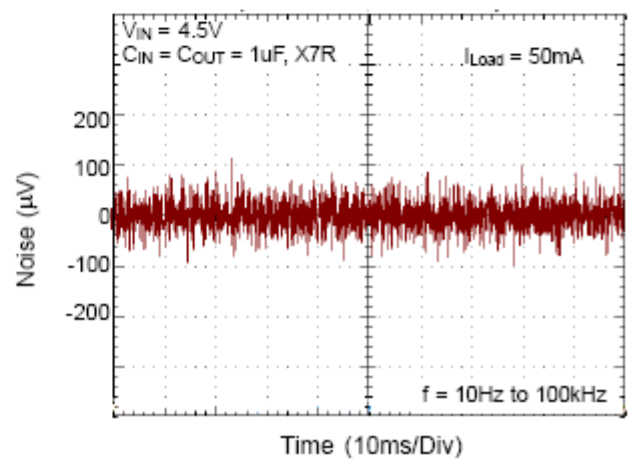
Line Transient Response



Noise



Noise



Applications Information

Like any low-dropout regulator, the external capacitors used with the LP3987 must be carefully selected for regulator stability and performance. Using a capacitor whose value is $> 1\mu\text{F}$ on the LP3987 input and the amount of capacitance can be increased without limit. The input capacitor must be located a distance of not more than

0.5 inch from the input pin of the IC and returned to a clean analog ground. Any good quality ceramic or tantalum can be used for this capacitor. The capacitor with larger value and lower ESR (equivalent series resistance) provides better PSRR and line-transient response. The output capacitor must meet both requirements for minimum amount of capacitance and ESR in all LDOs application. The LP3987 is designed specifically to work with low ESR ceramic output capacitor in space-saving and performance consideration. Using a ceramic capacitor whose value is at least $1\mu\text{F}$ with ESR is $> 25\text{m}\Omega$ on the LP3987 output ensures stability. The LP3987 still works well with output capacitor of other types due to the wide stable ESR range. Figure 1 shows the curves of allowable ESR range as a function of load current for various output capacitor values. Output capacitor of larger capacitance can reduce noise and improve load transient response, stability, and PSRR. The output capacitor should be located not more than 0.5 inch from the VOUT pin of the LP3987 and returned to a clean analog ground.

Start-up Function

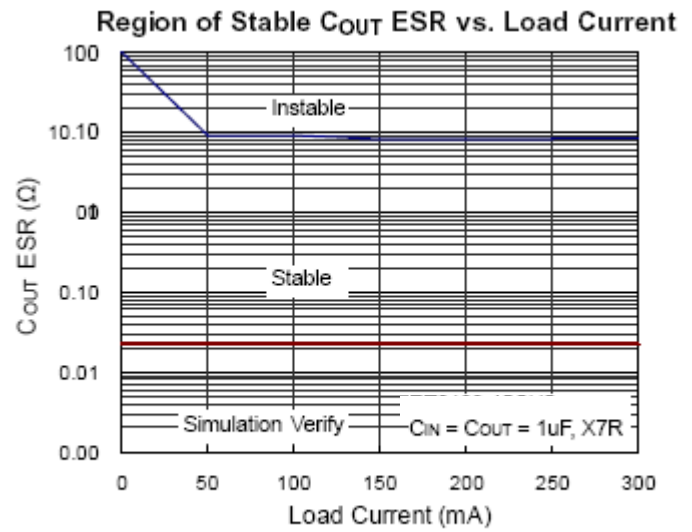
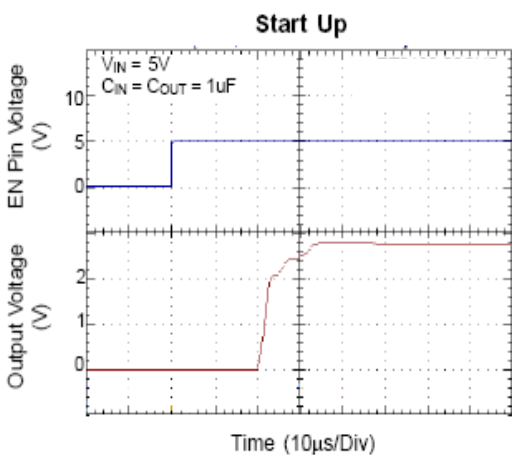


Figure 1

Enable Function

The LP3987 features an LDO regulator enable/disable function. To assure the LDO regulator will switch on, the EN turn on control level must be greater than 1.2 volts. The LDO regulator will go into the shutdown mode when the voltage on the EN pin falls below 0.4 volts. For protecting the system, the LP3987 have a quick-discharge function. If the enable function is not needed in a specific application, it may be tied to V_{IN} to keep the LDO regulator in a continuously on state.

Bypass Capacitor and Low Noise

Connecting a 22nF between the BP pin and GND pin significantly reduces noise on the regulator output, it is critical that the capacitor connection between the BP pin and GND pin be direct and PCB traces should be as short as possible. There is a relationship between the bypass capacitor value and the LDO regulator turn on time. DC leakage on this pin can affect the LDO regulator output noise and voltage regulation performance.

Thermal Considerations

Thermal protection limits power dissipation in LP3987. When the operation junction temperature exceeds 165°C , the OTP circuit starts the thermal shutdown function turn the pass element off. The pass element turn on again after the junction temperature cools by 30°C .

For continue operation, do not exceed absolute

maximum operation junction temperature 125°C. The power dissipation definition in device is :

$PD = (VIN - VOUT) \times IOUT + VIN \times IQ$ The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junction to ambient. The maximum power dissipation can be calculated by following formula :

$PD(MAX) = (TJ(MAX) - TA) / \theta_{JA}$ Where TJ(MAX) is the maximum operation junction temperature 125°C, TA is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance.

For recommended operating conditions specification of LP3987, where TJ(MAX) is the maximum junction temperature of the die (125°C)

and TA is the maximum ambient temperature. The junction to ambient thermal resistance (θ_{JA} is layout dependent) for SOT-23-5 package is 250°C/W.

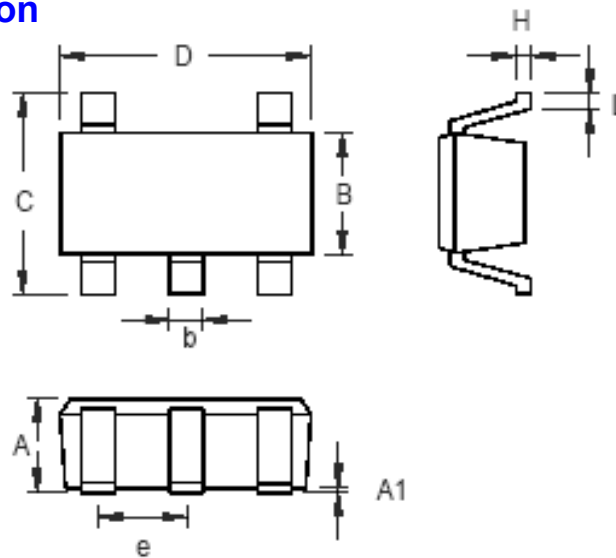
$PD(MAX) = (125^\circ C - 25^\circ C) / 250 = 400mW$ (SOT-23-5)

$PD(MAX) = (125^\circ C - 25^\circ C) / 165 = 606mW$

The maximum power dissipation depends on operating

ambient temperature for fixed TJ(MAX) and thermal resistance θ_{JA} .

Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.889	1.295	0.035	0.051
A1	0.000	0.152	0.000	0.006
B	1.397	1.803	0.055	0.071
b	0.356	0.559	0.014	0.022
C	2.591	2.997	0.102	0.118
D	2.692	3.099	0.106	0.122
e	0.838	1.041	0.033	0.041
H	0.080	0.254	0.003	0.010
L	0.300	0.610	0.012	0.024

SOT-23-5 Surface Mount Package